

Product Features

- 30 ~ 2650MHz
- High Gain
- High linearity
- SOIC-8 SMD Type package
- Lower manufacturing cost
- -72dBc CSO 79 Channels @ +40dBmV/ch
- -65dBc CTB 79 Channels @ +40dBmV/ch

Applications

- Low Noise Amplifier for CATV
- Cable Modem
- FTTH (G-PON, GE-PON)
- Optical node
- Repeater
- RF Sub-Systems
- Base Station
- Converter



Package Type : SOIC-8

Description

AE505 is designed as low cost drive amplifiers for many applications including FTTH, CATV System.

This MMIC is based on Gallium Arsenide Enhancement Mode pHEMT which shows low current draw and very low noise.

The data in this spec sheet is valid only for 75ohm application.

Electrical Specifications

PARAMETER		UNIT	MIN	TYP	MAX	CONDITION
Frequency		MHz	30	-	2650	-
Gain		dB	12	14	-	30 ~ 1000MHz
Gain Flatness		dB	-	1.5	-	30 ~ 1000MHz
Input Return Loss		dB	-	-13	-	-
Output Return Loss		dB	-	-15	-	-
Output IP3		dBm	38.5	41.5	-	@ 500MHz/10dBm 2tone
1dB Compression Point		dBm	21.5	24.5	-	@500MHz
Noise Figure		dB	-	3.4	4	@500MHz
CSO	30 ~ 1004MHz	dBc	-	-72	-	79 channel, Flat, +40dBmV/ch
CTB		dBc	-	-65	-	
DC Current		mA	-	220	-	Vdd = 5.0V

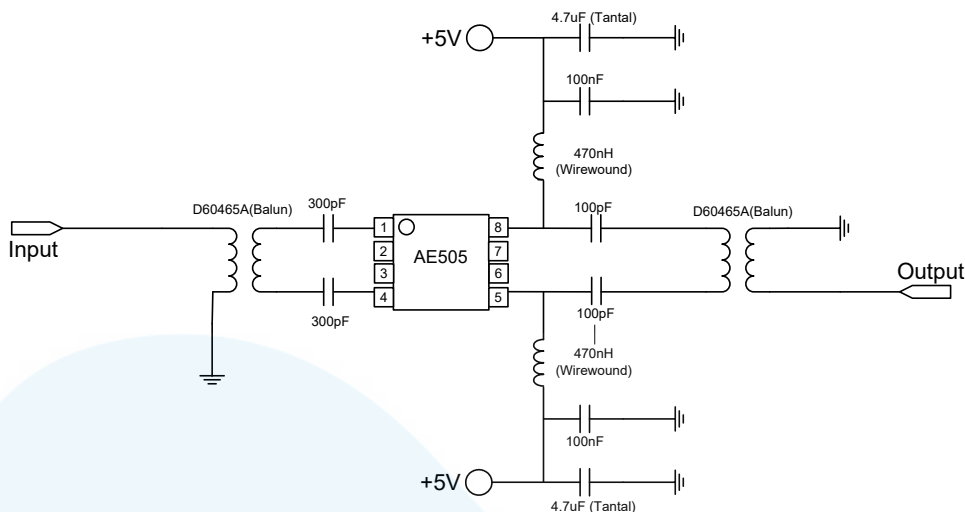
Note

1. Test conditions unless otherwise noted. Test Freq = 500MHz, T=25°C, Vdd=5V, 75Ω system
2. OIP3 measured with 2 tones at an output power of +10dBm/tone separated by 1MHz, Test Freq = 500MHz

Absolute Maximum Ratings

PARAMETER	UNIT	MIN	TYP	MAX
Device Voltage	VDC	-	5	12
Operating Temperature	°C	-40	-	85
Storage Temperature	°C	-40	-	150
ESD Human Body Model	-	-	Class 1A	-
Moisture Sensitivity Level	-	-	MSL1	-
Junction Temperature (Tj)	°C	-	-	180
Thermal Resistance (Rth)	°C/w	-	35	-

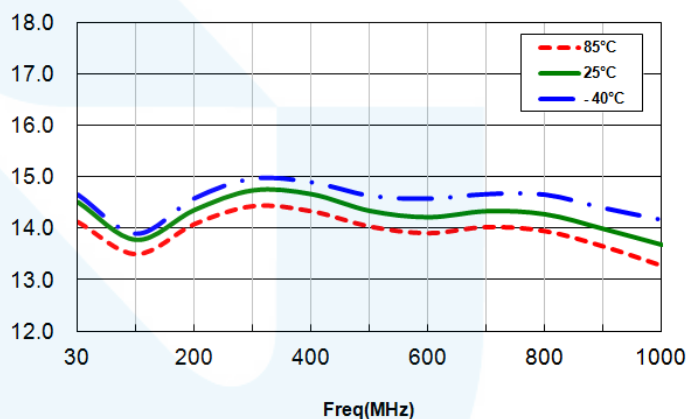
Application Circuit @ 30 ~ 1000MHz, 75ohm System, VDD=5V



Typical Performance @ VDD=5V, IDS=220mA, T=25°C, 75ohm System

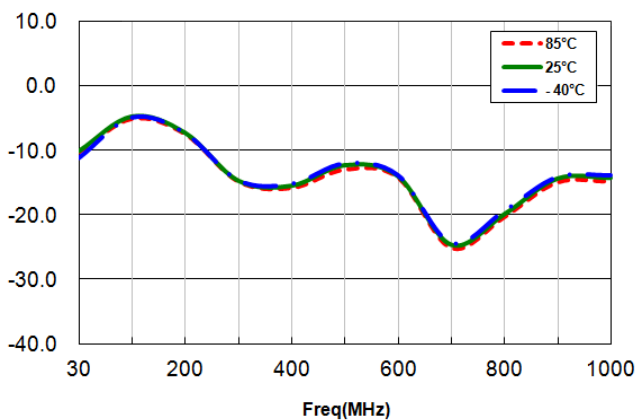
PARAMETER	UNIT	TYPICAL		
Frequency	MHz	30	500	1000
Gain(S21)	dB	14.8	14.3	13.6
Input Return Loss(S11)	dB	-10	-12	-14
Output Return Loss(S22)	dB	-10	-14.6	-24
Output IP3	dBm	39.3	41.5	36
1dB Compression Point	dBm	20.6	24.5	22.2
Noise Figure	dB	3.3	3.4	3.6
CSO*	dBc	-72		
CTB*	dBc	-65		
Current	mA	220		

Frequency vs. Gain

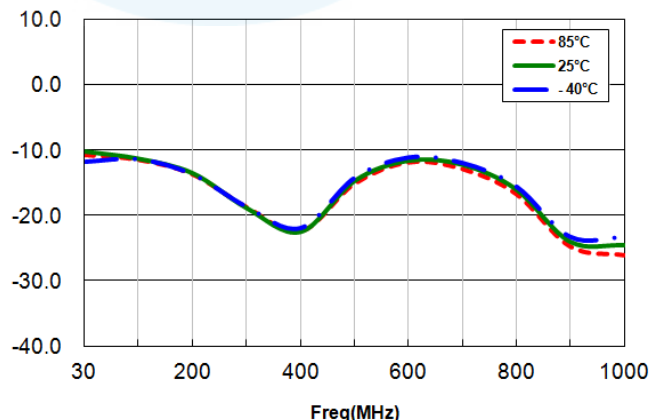


* 79channels_Flat, +40dBmV

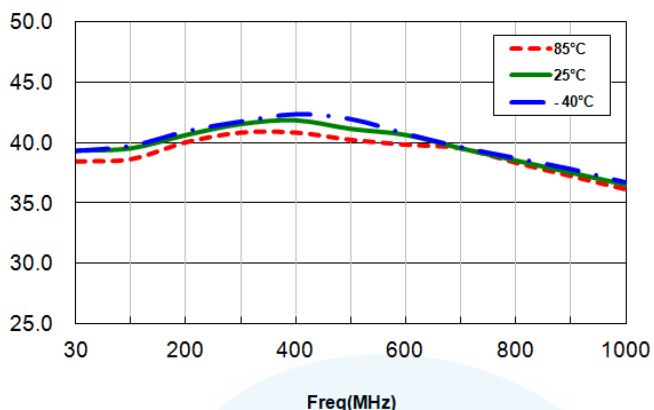
Frequency vs. S11



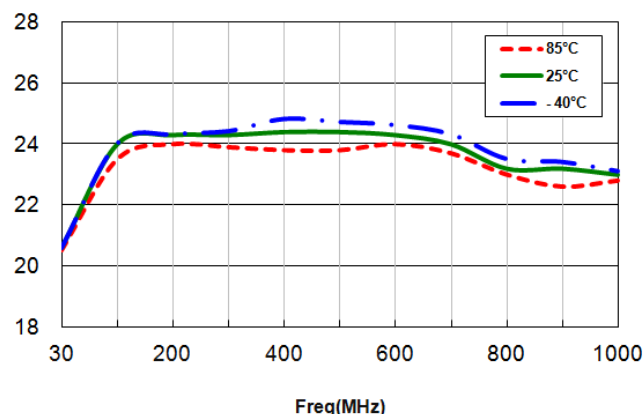
Frequency vs. S22



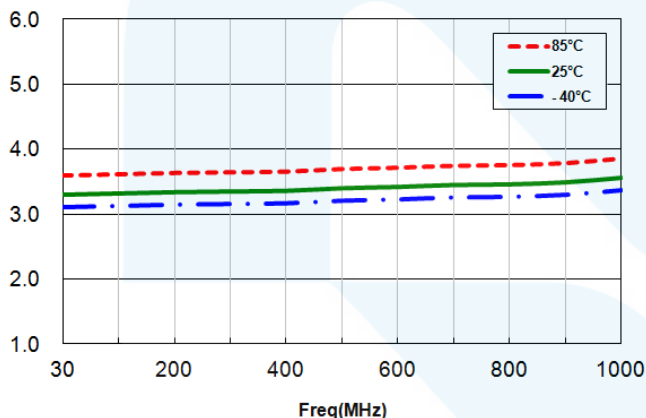
Frequency vs. OIP3



Frequency vs. P1dB



Frequency vs. Noise Figure

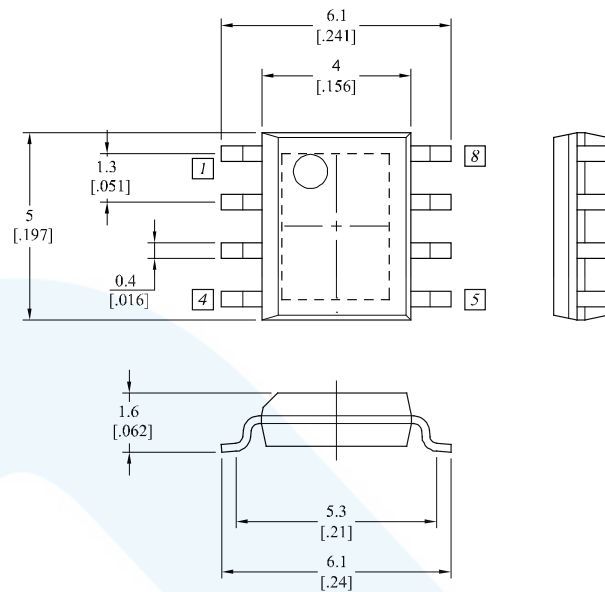


Multi-Tone Test : 79CH_FLAT@Output Power +40dBmV/Ch

Level: 40dBmV Tilt: 79CH_flat									
FRQ	CTB RAW	CTB COR	N-FLR	CSU RAW	CSU COR	CSU FRQ	CSL RAW	CSL COR	CSL FRQ
55.25	67	67	85.8	82.5	85.6	56	72.3	72.6	54
211.25	65	65	85.8	80.5	82.2	212.5	76	76.5	209.99
331.25	65.1	65.1	83.6	76	76.8	332.5	74.7	75.4	329.99
445.25	65.2	65.2	84.6	73.4	73.8	446.49	77.2	78	443.99
547.25	66.1	66.1	83.2	72	72	548.49	80.9	85.3	546.49
Min	65	65	83.2	72	72	56	72.3	72.6	54
Max	67	67	85.8	82.5	85.6	548.49	80.9	85.3	546.49

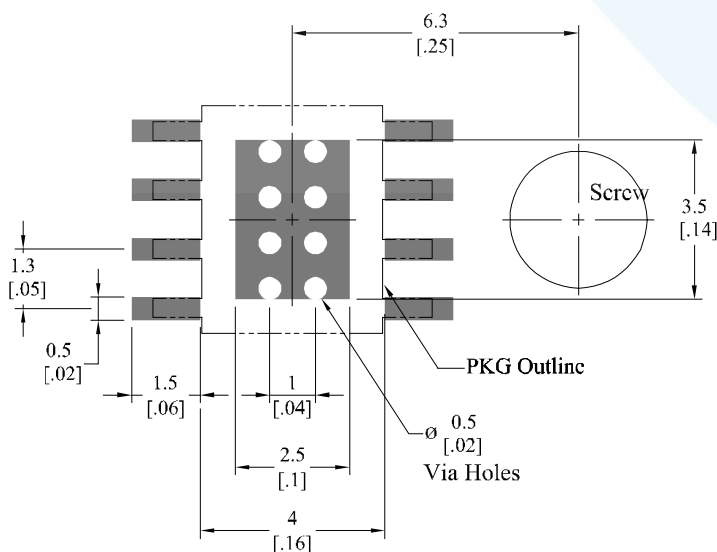
Package Dimensions (Type: SOIC-8)

* Unit: mm[inch] | Tolerance ± 0.2 [.008]



Pin Description			
Pin No	Function	Pin No	Function
1	RF IN(2)	5	RF OUT(1)
2	GND	6	GND
3	GND	7	GND
4	RF IN(1)	8	RF OUT(2)

Recommended Pattern



Mounting Configuration Notes

1. Ground / thermal via holes are critical for the proper performance of this device.
2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
3. Mounting screws can be added near the part to fasten the board to a heat sink. Ensure that the ground / thermal via hole region contacts the heat sink.
4. Do not put solder mask on the backside of the PCB in the region where the board contacts the heat sink.
5. RF trace width depends upon the PCB material and construction.
6. Use 1 oz. Copper minimum.

Revision History

Part Number	Release Date	Version	Modification	Data Sheet Status
AE505	20140721	1.0	Typical performance(2p)	-
AE505	20140519	0.1	Initial Release of Data sheet	Preliminary



Certification

This product is manufactured by a company that is certified for the AS9100D quality management system.

RFHIC Corporation reserves the right to make changes to any products herein or to discontinue any product at any time without notice. While product specifications have been thoroughly examined for reliability, RFHIC Corporation strongly recommends buyers to verify that the information they are using is accurate before ordering. RFHIC Corporation does not assume any liability for the suitability of its products for any particular purpose, and disclaims any and all liability, including without limitation consequential or incidental damages. RFHIC products are not intended for use in life support equipment or application where malfunction of the product can be expected to result in personal injury or death. Buyer uses or sells such products for any such unintended or unauthorized application, buyer shall indemnify, protect, and hold RFHIC Corporation and its directors, officers, stockholders, employees, representatives and distributors harmless against any and all claims arising out of such unauthorized use. All sales inquiries and support should be directed to the local authorized geographic distributor for RFHIC Corporation. For customers in the US, please contact the US sales team through our website at <https://rfhic.com/rfhic-us/>. For all other inquiries, please contact our international sales team through our website portal at <https://rfhic.com/contact/>